AMERICAN JOURNAL OF SOCIAL AND HUMANITARIAN RESEARCH



ISSN: 2690-9626 Vol. 3, No. 8, 2022

Properties of the Most Important Semiconductors

Nasriyeva Malika Xayrullo qizi

Master student, Department of Physics, Bukhara state University, Bukhara

Turayev Akmal Atayevich

Associate professor Department of Physics, Bukhara state University, Bukhara

ABSTRACT: The article examines the properties of semiconductors, the history of the creation of semiconductors and the semiconductors widely used in the field of technology are covered in detail.

KEYWORD: silicon (Si), germanium (Ge), gallium phosphide (GAP), gallium arsenide (GAAS), indium phosphide (INP), indium arsenide (INAS), indium antimonide (INSB).

INTRODUCTION

In human history, the 20th and 21st centuries have been called the age of electronics - microelectronics and nano-electronics. 2021 marks the 74th anniversary of the discovery of the first transistor by Shockley, D. Barden and W. Brettein (December 23, 1947), that is, the era of solid-state electronics began. This is a very small period for history.

Although the science of electronics, which was been formed and developed very quickly during this period, opened not only the way to space for mankind, but also unimaginable high-speed computing machines, completely new information systems, the most accurate and reliable diagnostic devices, not only enables the creation of compact, high-capacity electronic devices, but also radically improves the economy, military power, people's living standards, and employment conditions of the countries that pay attention to this field made it possible to solve environmental problems and continues to do so.

MAIN PART

Silicon (Si) - The most widely used substance in the production of semiconductor devices and systems is silicon. It ranks 14th in the periodic system of elements. Atomic weight is 28, its largest valency is 4, melting temperature (at normal pressure) is 1414 $^{\circ}$ C, density of solid silicon is 2.23*g/sm3*, dielectric permittivity *e*=11.7 is diamagnetic.

At room temperature, silicon is chemically stable, insoluble in water, resistant to many acids. Nevertheless, it dissolves well in a mixture of nitric and hydrofluoric acids:

 $3Si+4HNO_3+18HF=3H_2SiF_6+4NO+8H_2O$

Alkaline abrasives are used to clean the surface of silicon. For polishing, abrasives based on the above mixture are used.

44	ISSN 2690-9626 (online), Published by "Global Research Network LLC" under Volume: 3 Issue: 8 in Aug-2022 https://grnjournals.us/index.php/AJSHR
	Copyright (c) 2022 Author (s). This is an open-access article distributed under the terms of Creative Commons Attribution License (CC BY).To view a copy of this license, visit https://creativecommons.org/licenses/by/4.0/

Silica in alkaline solutions:

 $Si + 2KOH + H_2O = K_2SiO_3 + 2H_2$

According to the reaction, it dissolves well.

Silicon remains stable when heated in air up to 900 °C. However, it oxidizes at higher temperatures. Silicon directly reacts with hydrogen at a temperature of about 2000 °C, Si_nH_{2n+2} silanes are formed. Nitrogen reacts with silicon at 1100° C- 1300° Cda to form nitrites. Silicon reacts easily with halogens: with fluorine at room temperature at 200° C- 500° C with chlorine, with iodine at 700° C- 750° C.

Liquefied silicon will have high activity. The best material for growing silicon nanocrystals is

synthetic quartz-SiO₂.

Electrical properties. It is known that the electrical conductivity of semiconductors is described by the expression $\sigma = e(n\mu_n + \rho u_p)$. In the *n*-type semiconductor, the conductivity $\sigma = e n\mu_n$ should be equal to (at the temperature at which the input is fully ionized) the density of electrons is n, and the density of the donor input should be equal to N_d , that is, N_d . This equality is maintained up to a certain number of inputs. Nevertheless, this equality does not hold when the input density is high enough (n< N_d).

This phenomenon is called "polytropy of alloying elements". The reason for this is that a sufficiently large amount of charge introduced into the semiconductor can be in different states. For example, atoms of the input semiconductor or defects in its structure form connections, are located between nodes, etc. it can. In one of these cases, the input may be electrically active in the crystal, in others, it may be in a neutral state. The stability of the alloying elements at which the phenomenon of polytropy starts to occur is called the threshold stability.

At higher concentrations, the semiconductor becomes a strong alloying agent. Electron (E) single crystals of silicon (K) are alloyed with phosphorus (F), hollow type is alloyed with boron (B). Therefore, they are designated as KEF or KDB. Silicon is obtained by reducing trichlorosilane with hydrogen:

$SiHCl_3+H_2 \rightarrow Si+3HCl.$

GERMANIUM (GE) - It ranks 32nd in the periodic system of elements, atomic weight is 72.5, greatest valence is 4, melting point is 936 °C, density is 5.3 g/sm^3 , dielectric strength is 16, it is diamagnetic. Germanium is chemically stable at room temperature. It is almost insoluble in water. Nitrogen with a density of 2-3 mol/liter is readily soluble in an acid solution, but when the acid density increases, a film of GeO_2 oxide forms on the surface, and the solubility decreases greatly. At room temperature, germanium is actively dissolved by horn vodka (HF), hydrogen H_2O_2 oxide andoxidizing agents.

If it is heated above 700° in air, germanium is oxidized, and at this temperature, it is also oxidized by carbon monoxide. GeO oxide is a black powder that can be easily driven above 700°. Above 1000°, germanium reacts with hydrogen to form GeO_2H_{2n+2} compounds. Nevertheless, it does not interact with nitrogen. Liquid germanium does not react with either carbon (C) or silicon oxide ((SiO_2)) at temperatures up to 1500° C. Due to this property, germanium can be stored in graphite and quartz vessels. The electrical properties of germanium are similar to those of silicon in many respects because they are group IV elements. Germanium IV oxide is usually obtained by hydrolyzing purified tetrachloride in water.

 $\text{Gelu+}2H_2\text{O} \rightarrow \text{GeO}_2\text{+}4\text{HCL}$

By reducing GeO_2 IV oxide with pure hydrogen, elemental germanium is obtained:

 $GeO_2 + 2H_2 \rightarrow Ge + 2H_2O$

45	ISSN 2690-9626 (online), Published by "Global Research Network LLC" under Volume: 3 Issue: 8 in Aug-2022 https://grnjournals.us/index.php/AJSHR
	Copyright (c) 2022 Author (s). This is an open-access article distributed under the terms of Creative Commons Attribution License (CC BY).To view a copy of this license, visit https://creativecommons.org/licenses/by/4.0/

GALLIUM PHOSPHIDE (GaP) - Gallium phosphide has a high chemical stability: it does not react with oxygen in the air up to 700°C-800°C: it is stable against many oxygen and alkaline solutions. The rate of dissolution of gallium phosphide in nitric acid (at room temperature) is $0.16mg/sm^2$ hours, in a boiling (1:3) mixture of nitric and hydrochloric acids, it is $7.8mg/sm^2$ hours. When hydrogen peroxide is added to the acid mixture, the solubility of GaP increases dramatically. When gallium phosphide dissolves in acids, the highly toxic phosphine PH_3 is released. Other $A^{III}B^{IV}$ compounds also react with acids in the same way.

GaAs and InAs-asrin AsH_3 ; release toxic substances consisting of InP-phosphine PH_3 and INSb-stibine SbH_3 . Liquid GaP reacts actively with all container substances, because its melting temperature is -1500°C. Top-pure graphite for synthesizing polycrystalline GaP. Quartz serves as a container for monocrystalline GaP growth. In semiconductor $A^{III}B^{IV}$ compounds (GaAs, GaP...), elements of group II are acceptors; elements of group IV are donors.

If atoms of IV group elements are located instead of gallium atoms, they act as donors, if phosphorus is located instead of axenium, they act as acceptors. Unalloyed GaP has electronic type conductivity, where $n>1*10^{17} sm^{-3}$ and $\mu<120 sm^2/vs$. In GaP crystals doped with Te and S, the main charge carriers-electrons-stability (1,25:40) $10^{17} sm^{-3}$, mobility (110-60) sm^2/vs . Cavity type GaP has a mobility of $20 sm^2/vs$. The resistivity of basic GaP is more than 10^6 Om cm.

GALLIUM ARSENIDE (GaAs) - Gallium arsenide does not react with water, actively reacts with acids and produces toxic AsH_3 arsine. The solubility of gallium arsenide is much greater in a mixture of acids. Its solubility in a hydrochloric acid solution is $2 * 10^{-5}mg/sm^2$ hours, in an aqueous mixture of hydrochloric and nitric acids (1:1:1) - 60 mg/sm^2 hours, in an aqueous solution of nitric and hydrofluoric acids - 1200. When heated to 300°C, GaAs does not oxidize, from 300°C it decomposes and releases arsenic.

Liquid GaAs is very active. Synthetic quartz (SiO_2) is most often used in GaAs technology. Density of GaAs is 5.2 g/sm^3 , melting temperature is 1238^{0} C. Unalloyed GaAs single crystals have n-type conductivity, where n< $6.10^{6}sm^{-3}$ and mobility μ > $4200sm^{3}/vc$ (300K) n-GaAs single crystal is doped with Zn. In most cases, when GaAs (semi-insulating) single crystals are alloyed with chromium Cr, their specific resistance is from 1 * 10^{5} to 1 * 10^{7} ohm cm. GaAs crystals are grown in [111] and [100] directions.

INDIA PHOSPHIDE (INP) - InP is insoluble in water. Its best solvent is hydrochloric acid, and as the acid concentration increases, the dissolution rate of InP increases, but it also releases PH_3 toxic phosphine. Stability $4.8g/sm^3$, melting temperature 1058°C. When heated up to 300°C, InP does not oxidize, at higher temperatures it decomposes and releases phosphorus. Liquid InP interacts poorly with quartz, so synthetic quartz is used in InP growth devices.

In unalloyed InP crystals, the density of charge carriers does not exceed $5 * 10^{16} \ sm^{-3}$, and the mobility does not exceed 3000 $sm^2/vc.$ n - InP single crystals are alloyed with Te and Sn. They have n = (5:500) $10^{16} \ sm^{-3}$; μ_n = (2500:1000) $sm^2/vc.$ P = (5:8) * $10^{17} \ sm^{-3}$. in p-LnP doped with zinc. Semi-insulating LnP single crystals are alloyed with iron (Fe). Them $p > 1 * 107 \ om^* \ sm$.

INDIUM ARSENIDE (InAs) - InAs is insoluble in water, the rate of corrosion in hydrochloric acid at +750C is $300mg/(cm^2hours)$. If nitric acid is added, this rate increases. When InAs dissolves in acids, toxic As H_3 arsine is released. Above 450°C, InAs oxidizes in air. In vacuum, near and above 7000C, InAs decomposes, releasing arsenic. Stability 5.67 g/sm^3 , melting temperature 942°C. In undoped indium arsenide single crystals, the stability (3:5) $10^{16}sm^{-3}$ and mobility (3:4) 10^4sm^2 of the main charge carriers /vs (at 77 K). InAs single crystals doped with Te and Sn have p-type conductivity, n = (1. $10^{16} : 8 * 10^{19}) sm^{-3}$ (at 77K). InAs crystals are grown in the [111] direction.

46	ISSN 2690-9626 (online), Published by "Global Research Network LLC" under Volume: 3 Issue: 8 in Aug-2022 https://grnjournals.us/index.php/AJSHR
	Copyright (c) 2022 Author (s). This is an open-access article distributed under the terms of Creative Commons Attribution License (CC BY).To view a copy of this license, visit https://creativecommons.org/licenses/by/4.0/

INDIUM ANTIMONIDE (InSb) - InSb is insoluble in water, it is easily digested by acids: the rate of digestion in nitric acid is $360mg/(cm^2min)$, in a HNO_3 ; HF; $H_2O = 1:1:1$ mixture - $480 mg/(cm^2min)$, etc. When InSb dissolves in SbH_3 acids, toxic stibin is released. Density of InSb is 5.78 gr/sm^3 , melting temperature is 525° C. Oxidation of InSb in air starts above 525° C.

Unalloyed or alloyed with Ge, Zn or Mn InSb single crystals have p-type conductivity:

 $p = (1 * 10^{12}: 1 * 10^{18})sm^{-3}$, $p \approx 500m$. $sm \mu = (3: 5)10^3 sm^2/vs$ (77K). Tellurium- doped InSb <Te> single crystals have n-type conductivity: $n = (8 * 10^{13}: 5 * 10^{18})sm^{-3}$, $p \approx 500m sm$, $\mu = (7: 8) 10^5 sm^2/vs$ (77K). Indium antimonide InSb single crystals are grown in (211) crystallographic direction.

CONCLUSION

In conclusion, it can be noted that the concentration of electrons in semiconductors is low (much less compared to metals) and it depends on external factors. Under the influence of an external electric field, free electrons move and create electronic conductivity (N-conductivity). Under the influence of an external electric field, the holes move in the direction of the field. The displacement of these holes is equivalent to a current of positive charges equal in magnitude to the charge of electrons. This process is called hole conductivity and hole conductivity.

REFERENCES

- 1. M.Ismoilov , P.Xabibullayev , M. Xaulin. "Fizika kursi". Toshkent, O'zbekiston, 2000-y.
- Abdulkhaev, O. A., Yodgorova, D. M., Karimov, A. V., Kamanov, B. M., & Turaev, A. A. (2013). Features of the temperature properties of a field-effect transistor in a current-limiting mode. *Journal of Engineering Physics and Thermophysics*, 86(1), 248-254.
- 3. Karimov, A. V., Dzhuraev, D. P., Kuliev, S. M., & Turaev, A. A. (2016). Distinctive features of the temperature sensitivity of a transistor structure in a bipolar mode of measurement. *Journal of Engineering Physics and Thermophysics*, 89(2), 514-517.
- 4. Файзиев, Ш. Ш., Саидов, К. С., & Аскаров, М. А. У. (2020). Зависимость магнитно модулированной структуры от ориентации поля в кристалле FeBO3: Mg. Вестник науки и образования, (18-2 (96)), 6-9.
- 5. Очилов, Л. И., Арабов, Ж. О., & Ашурова, У. Д. (2020). Измерение преобразования потенциальной энергии в поступательную и вращательную энергию с помощью колесамаксвелла. Вестник науки и образования, (18-2 (96)), 18-22.
- 6. Очилов, Л. И. (2016). Технология приготовления фитиля из капиллярно-полых материалов. *Молодой ученый*, (12), 360-362.
- 7. Qoʻyliyev B.T. Tabiatning fizik xossalari bitmas-tuganmasdir. Qarshi, 2005 y.
- 8. Nigmatov K. Radioelektronika asoslari. T., 1994 y.
- 9. Dzhuraev, D. R., & Turaev, A. A. (2020). Features of key parameters of field transistors. *Scientific* reports of Bukhara State University, 3(2), 7-10.
- 10. Каримов, А. В., Джураев, Д. Р., Ёдгорова, Д. М., Рахматов, А. З., Абдулхаев, О. А., Каманов, Б. М., & Тураев, А. А. (2011). Некоторые особенности ограничителя тока на полевом транзисторе. *Технология и конструирование в электронной аппаратуре*.
- 11. Djuraev, D. R., Karimov, A. V., Yodgorova, D. M., & Turaev, A. A. (2019). The principles of increasing the sensitivity of transistor structures to external influences. *Euroasian Journal of Semiconductors Science and Engineering*, 1(1), 2.

47	ISSN 2690-9626 (online), Published by "Global Research Network LLC" under Volume: 3 Issue: 8 in Aug-2022 https://grnjournals.us/index.php/AJSHR
	Copyright (c) 2022 Author (s). This is an open-access article distributed under the terms of Creative Commons Attribution License (CC BY).To view a copy of this license, visit https://creativecommons.org/licenses/by/4.0/

- Karimov, A. V., Djuraev, D. R., Abdulhaev, O. A., Rahmatov, A. Z., Yodgorova, D. M., & Turaev, A. A. (2016). Tenso properties of field-effect transistors in channel cutoff mode. *International Journal of Engineering Inventions e-ISSN*, 2278-7461.
- 13. Rajabov N. CURRENT STATUS AND DEVELOPMENT PROSPECTS OF ENVIRONMENTAL REGULATORY SYSTEM (HISTORICAL AND LEGAL ANALYSIS) //Review of law sciences. 2020. T. 4. №. 2. C. 133-139.
- Karimov, A. V., Dzhuraev, D. R., Edgorova, D. M., Rahmatov, A. Z., Abdulhaev, O. A., Kamanov, B. M., & Turaev, A. A. (2011). Nekotorye osobennosti ogranichitelya toka na polevom tranzistore. Tehnologiya i konstruirovanie v elektronnoj apparature, (1-2), 90.
- 15. Rahmatov, A. Z., Abdulkhaev, O. A., Karimov, A. V., & Yodgorova, D. M. (2013). Features of the performance of a transient voltage suppressor in the pulsed mode. Semiconductors, 47(3), 387-391.
- 16. Абдулхаев, О. А., Ёдгорова, Д. М., Каримов, А. В., Каманов, Б. М., & Тураев, А. А. (2013). Особенности температурных свойств полевого транзистора в режиме ограничения токов. Инженерно-физический журнал, 86(1), 232-237.
- 17. Файзиев, Ш. Ш., Саидов, К. С., & Низомова, Ш. К. К. (2020). Электронная структура основного мультиплета иона диспрозия в ортоалюминате. Academy, (11 (62)), 4-6.
- 18. Б. М. Я ворский, А.А.Детлаф. «Курсфизики» І-Штом. М: "Высшая школа" 1994 г
- 19. Sharifbaevich, R. N. (2022). Digitalization of Environmental Regulation: Legal Aspects. American Journal of Social and Humanitarian Research, 3(6), 374–380. Retrieved from https://www.grnjournals.us/index.php/ajshr/article/view/1263
- 20. Teshaboev A, Zaynobiddinov S, va boshq. Yarimo`tkazgich asboblar fizikasi. Toshkent. 2005 y.
- 21. Abdulkhaev, O. A., Asanova, G. O., Yodgorova, D. M., Karimov, A. V., Dzhuraev, D. R., & Turaev, A. A. (2011). The optical signal transfer and reception modules via atmosphere.
- 22. Rakhmatov, A. Z., Kamanov, B. M., Dzhuraev, D. R., & Turaev, A. A. (2010). Research the drain characteristics of field-effect transistor as current limiter.
- 23. Rakhmatov, A. Z., Kamanov, B. M., Dzhuraev, D. R., & Turaev, A. A. (2010). Research the drain characteristics of field-effect transistor as current limiter; Issledovanie stokovykh kharakteristik polevogo tranzistora v kachestve ogranichitelya toka.
- 24. Rakhmatov, A. Z., Kamanov, B. M., Dzhuraev, D. R., & Turaev, A. A. (2010). Research the drain characteristics of field-effect transistor as current limiter; Issledovanie stokovykh kharakteristik polevogo tranzistora v kachestve ogranichitelya toka.
- 25. Turaev, A. A., & KS, S. (2016). Dinamik yuklamali sxemada maydoniy tranzistorning kuchaytirish xossalari. Buxoro davlat universiteti ilmiy axboroti, 4(64), 31-35.
- 26. Abdulkhayev, O. A., Dzhurayev, D. R., Yodgorova, D. M., Karimov, A. V., Rakhmatov, A. Z., & Turaev, A. A. (2016). Physico-technological aspects multifunctional sensor on field- effect transistor. New Trends of Development Fundamental and Applied Physics: Problems, Achievements and Prospects, 10-11.
- 27. Abdulkhaev, O. A., Asanova, G. O., Yodgorova, D. M., Karimov, A. V., Dzhuraev, D. R., & Turaev, A. A. (2011). The optical signal transfer and reception modules via atmosphere.
- 28. Rakhmatov, A. Z., Kamanov, B. M., Dzhuraev, D. R., & Turaev, A. A. (2010). Research the drain characteristics of field-effect transistor as current limiter; Issledovanie stokovykh kharakteristik polevogo tranzistora v kachestve ogranichitelya toka.
- 29. Juraev, D. R., Nazarova, M., & Turaev, A. (2010). The atmospheric optical communication link of new generation; Atmosfernye opticheskie linii svyazi novogo pokoleniya.

48	ISSN 2690-9626 (online), Published by "Global Research Network LLC" under Volume: 3 Issue: 8 in Aug-2022 https://grnjournals.us/index.php/AJSHR
	Copyright (c) 2022 Author (s). This is an open-access article distributed under the terms of Creative Commons Attribution License (CC BY).To view a copy of this license, visit https://creativecommons.org/licenses/by/4.0/